

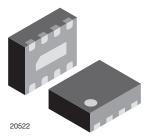
# 8-Line ESD-Protection Diode Array in LLP1713-9L

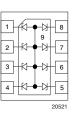
#### **Features**

- Ultra compact LLP1713-9L package
- Low package profile < 0.6 mm
- 8-line ESD-protection
- Low leakage current I<sub>R</sub> < 1 μA</li>
- Low load capacitance C<sub>D</sub> = 30 pF
- ESD-immunity acc. IEC 61000-4-2
  - ± 25 kV contact discharge ± 30 kV air discharge
- Working voltage range V<sub>RWM</sub> = 5 V
- e4 precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC









### Marking (example only)



Dot = Pin 1 marking Y = Type code (see table below) XX = Date code

### **Ordering Information**

Device name	Device name Ordering code		Minimum order quantity		
VESD05A8A-HNH	VESD05A8A-HNH-GS08	3000	15 000		

### **Package Data**

Device name	Package name	Marking code	Weight	Molding compound flammability rating	Moisture sensitivity level	Soldering conditions
VESD05A8A-HNH	LLP1713-9L	В	3.7 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

<sup>\*\*</sup> Please see document "Vishay Material Category Policy" www.vishay.com/doc?99902

# **VESD05A8A-HNH**

### Vishay Semiconductors



### **Absolute Maximum Ratings**

Rating	Test conditions	Symbol	Value	Unit	
Peak pulse current	BiAs-mode: each input (pin 1 - pin 8) to ground (pin acc. IEC 61000-4-5; $t_p = 8/20 \mu s$ ; single shot	I <sub>PPM</sub>	5	Α	
		BiSy-mode: each input (pin 1 - pin 8) to any other input pin. Pin 9 not connected. Acc. IEC 61000-4-5; $t_p = 8/20 \mu s$ ; single shot			
Deale mules manuar	BiAs-mode: each input (pin 1 - pin 8) to ground (pin acc. IEC 61000-4-5; t <sub>p</sub> = 8/20 μs; single shot	P <sub>PP</sub>	65	W	
Peak pulse power	BiSy-mode: each input (pin 1 - pin 8) to any other inp Pin 9 not connected. Acc. IEC 61000-4-5; $t_p$ = 8/20 $\mu$ s; s	P <sub>PP</sub>	33	W	
ESD-immunity	Acc. IEC61000-4-2; 10 pulses BiAs-mode: each input (pin 1 - pin 8) to ground (pin 9)	Contact discharge	V <sub>ESD</sub>	± 25	kV
		Air discharge	V <sub>ESD</sub>	± 30	kV
	Acc. IEC 61000-4-2; 10 pulses BiSy-mode: each input (pin 1 - pin 8) to any other input pin.	Contact discharge	V <sub>ESD</sub>	± 12	kV
	Pin 9 not connected.	Air discharge	V <sub>ESD</sub>	± 12	kV
Operating temperature	Junction temperature			- 40 to + 125	°C
Storage temperature				- 55 to + 150	°C

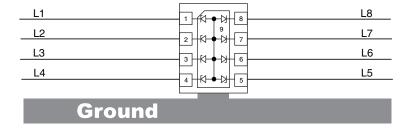
### BiAs-Mode (8-line Bidirectional Asymmetrical protection mode)

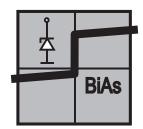
With the **VESD05A8A-HNH** up to 8 signal- or data-lines (L1 - L8) can be protected against voltage transients. With pin 9 connected to ground and pin 1 up to pin 8 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified **Maximum Reverse Working Voltage** (**V**<sub>RWM</sub>) the protection diode between data line and ground offer a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the break through voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage  $(V_C)$  is defined by the BReakthrough Voltage  $(V_{BR})$  level plus the voltage drop at the series impedance (resistance and inductance) of the protection device.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction of the protection diode. The low Forward Voltage ( $V_F$ ) clamps the negative transient close to the ground level.

Due to the different clamping levels in forward and reverse direction the **VESD05A8A-HNH** clamping behaviour is **Bi**directional and **As**ymmetrical (**BiAs**).





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#### **Electrical Characteristics**

Ratings at 25 °C, ambient temperature unless otherwise specified

#### VESD05A8A-HNH

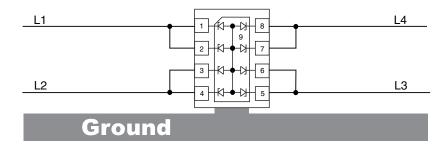
BiAs mode: each input (pin 1 - pin 8) to ground (pin 9)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of line which can be protected	N lines			8	lines
Reverse current	at I <sub>R</sub> = 1 μA	V <sub>RWM</sub>	5			V
Max. reverse current	at V <sub>R</sub> = V <sub>RWM</sub> = 5 V	I <sub>R</sub>		< 0.1	1	μΑ
Min. reverse breakdown voltage	at I <sub>R</sub> = 1 mA	V <sub>BR</sub>	6		8	V
Max. clamping voltage	at I <sub>PP</sub> = 5 A acc. IEC 61000-4-5	V <sub>C</sub>			13	V
Max. forward clamping voltage	at I <sub>F</sub> = 5 A acc. IEC 61000-4-5	V <sub>F</sub>			4.5	V
Line capacitance	at $V_R = 0 V$ ; $f = 1 MHz$	C <sub>D</sub>		30	35	pF
	at V <sub>R</sub> = 2.5 V; f = 1 MHz	C <sub>D</sub>		18	23	pF

If a higher surge current or Peak Pulse current (I<sub>PP</sub>) is needed, some protection diodes in the VESD05A8A-HNH can also be used in parallel in order to "multiply" the performance.

If two diodes are switched in parallel you get

- double surge power = double peak pulse current (2 x I<sub>PPM</sub>)
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line Capacitance (2 x C<sub>D</sub>)
- double Reverse leakage current (2 x I<sub>R</sub>)



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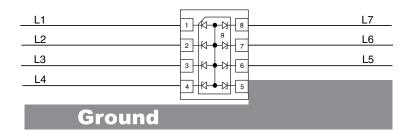


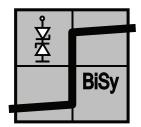
### BiSy-mode (7-line Bidirectional Symmetrical protection mode)

If a bipolar symmetrical protection device is needed the **VESD05A8A-HNH** can also be used as a seven-line protection device. Therefore seven pins (example: pin 1, 2, 3, 4, 6, 7 and 8) has to be connected to the signal-or data-line (L1 - L7) and pin 5 to ground. Pin 9 must not be connected!

Positive and negative voltage transients will be clamped in the same way. The clamping current from one data line through the **VESD05A8A-HNH** to the ground passes one diode in forward direction and the other one in reverse direction. The **C**lamping **V**oltage ( $V_C$ ) is defined by the **BR**eakthrough **V**oltage ( $V_{BR}$ ) level of one diode plus the forward voltage of the other diode plus the voltage drop at the series impedances (resistances and inductances) of the protection device.

Due to the same clamping levels in positive and negative direction the **VESD05A8A-HNH** voltage clamping behaviour is also <u>Bi</u>directional and <u>Sy</u>mmetrical (**BiSy**).





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#### **Electrical Characteristics**

Ratings at 25 °C, ambient temperature unless otherwise specified

#### VESD05A8A-HNH

BiSy mode: each input (pin 1 - pin 8) to any other input pin connected to ground; pin 9 not connected

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of line which can be protected	N <sub>lines</sub>			7	lines
Reverse current	at I <sub>R</sub> = 1 μA	V <sub>RWM</sub>	5.5			V
Max. reverse current	at V <sub>R</sub> = V <sub>RWM</sub> = 5.5 V	I <sub>R</sub>		< 0.1	1	μΑ
Min. reverse breakdown voltage	at I <sub>R</sub> = 1 mA	$V_{BR}$	6.5		8.7	V
Max. clamping voltage	at I <sub>PP</sub> = 2.5 A acc. IEC 61000-4-5	V <sub>C</sub>			13	٧
Line capacitance	at $V_R = 0 V$ ; $f = 1 MHz$	C <sub>D</sub>		15	18	pF
	at V <sub>R</sub> = 2.5 V; f = 1 MHz	C <sub>D</sub>		13	15	pF





### **Typical Characteristics**

T<sub>amb</sub> = 25 °C, unless otherwise specified

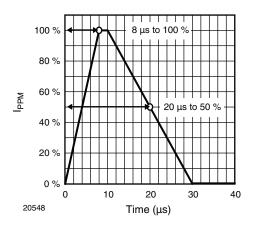


Figure 1. 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5

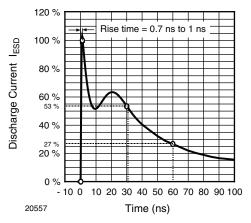


Figure 2. ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330  $\Omega/150$  pF)

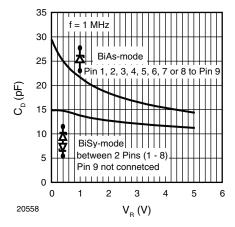


Figure 3. Typical Capacitance C<sub>D</sub> vs. Reverse Voltage V<sub>R</sub>

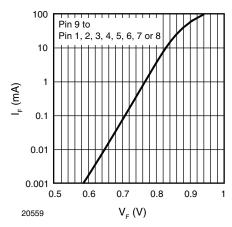


Figure 4. Typical Forward Current I<sub>F</sub> vs. Forward Voltage V<sub>F</sub>

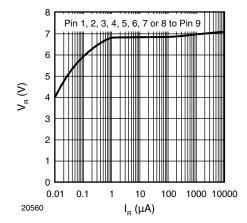


Figure 5. Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$ 

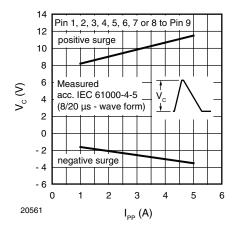


Figure 6. Typical Peak Clamping Voltage  $V_{\rm C}$  vs. Peak Pulse Current  $I_{\rm PP}$ 



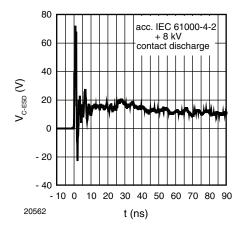


Figure 7. Typical Clamping Performance at + 8 kV Contact Discharge (Acc. IEC 61000-4-2)

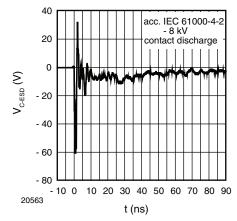


Figure 8. Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)

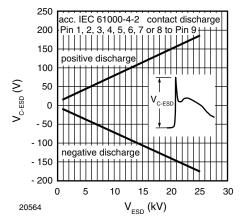
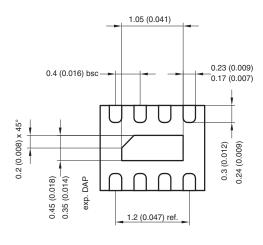
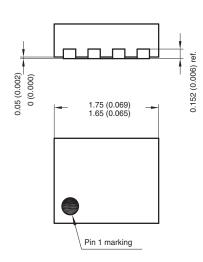
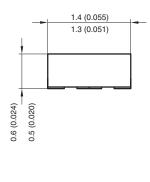


Figure 9. Typical Peak Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)

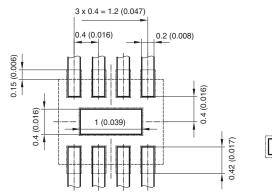
## Package Dimensions in millimeters (inches): LLP1713-9L







Foot print recommendation:



Document no.:S8-V-3906.04-001 (4) Created - Date: 28. August 2006 Rev. 1 - Date: 27. May 2008 20386 Solder

resist mask

Solder pad

# **Legal Disclaimer Notice**



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